

Chun-Feng Wu

Curriculum Vitae



PERSONAL DETAILS

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EDUCATION

Postdoctoral Scholar Department of Computer Science **2021-Now**
GPA: NaN
Harvard University, USA
Advisor: David M. Brooks
Topics: Recommender Systems, Computation-in-Storage

Ph.D. Department of CSIE **2016-2021**
GPA: 4.17/4.30
National Taiwan University, Taiwan
Advisor: Tei-Wei Kuo & Yuan-Hao Chang
Dissertation: Support to Huge Main-Memory Extension with Non-Volatile Memory

MSc. Department of Computer Science **2014-2016**
GPA: 3.90/4.30
National Tsing Hua University, Taiwan
Advisor: Yeh-Ching Chung
Thesis: Hybrid Mechanisms to Improve Write Scenarios for Cloud Storage Services

BSc. Department of CSIE **2010-2014**
GPA: 3.72/4.0
National Central University, Taiwan
Advisor: Li-Der Chou

RESEARCH INTERESTS

Memory/storage systems and architectures, Operating systems, AI Accelerator Designs (e.g., CrossBar), Next-Generation Non-Volatile Memory and Embedded systems.

PUBLICATIONS

Journal Papers

1. **Chun-Feng Wu**, Martin Kuo, Ming-Chang Yang, and Yuan-Hao Chang, "Performance Enhancement of SMR-based Deduplication Systems", accepted and to appear in IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD).
2. Shuo-Han Chen, **Chun-Feng Wu**, Ming-Chang Yang, and Yuan-Hao Chang, "A File-Oriented Fast Secure Deletion Strategy for Shingled Magnetic Recording Drives", accepted and to appear in IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD).
3. Che-Wei Chang, **Chun-Feng Wu**, Yuan-Hao Chang, Ming-Chang Yang, and Chieh-Fu Chang, "Leveraging Write Heterogeneity of Phase Change Memory on Supporting Self-balancing Binary Tree", accepted and to appear in IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD).
4. Dharamjeet, Tseng-Yi Chen, Yuan-Hao Chang, **Chun-Feng Wu**, Chi-Heng Lee, Wei-Kuan Shih, "Beyond Write-reduction Consideration: A Wear-leveling-enabled B+-tree Indexing

- Scheme over an NVRAM-based Architecture” , accepted and to appear in IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD).
5. Wen Sheng Lim, Chia-Heng Tu, **Chun-Feng Wu**, and Yuan-Hao Chang, “iCheck: Progressive Checkpointing for Intermittent Systems” , accepted and to appear in IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD).
 6. **Chun-Feng Wu**, Yuan-Hao Chang, Ming-Chang Yang, and Tei-Wei Kuo, “When Storage Response Time Catches Up with Overall Context Switch Overhead, What is Next?” , accepted and to appear in IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD). (Integrated with ACM/IEEE CODES+ISSS’20).
 7. Yao-Wen Kang, **Chun-Feng Wu**, Yuan-Hao Chang, Tei-Wei Kuo and Shu-Yin Ho, “On Minimizing Analog Variation Errors to Resolve the Scalability Issue of ReRAM-based Crossbar Accelerator” , accepted and to appear in IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD). (Integrated with ACM/IEEE EMSOFT’20).
 8. Gaddisa Olani Ganfure, **Chun-Feng Wu**, Yuan-Hao Chang, and Wei-Kuan Shih, “DeepPrefetcher: A Deep Learning Framework for Data Prefetching in Flash Storage Devices” , accepted and to appear in IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD). (Integrated with ACM/IEEE CASES’20).
 9. Ming-Chang Yang, **Chun-Feng Wu**, Shuo-Han Chen, Yi-Ling Lin, Che-Wei Chang, and Yuan-Hao Chang, “On Minimizing Internal Data Migrations of Flash Devices via Lifetime-Retention Harmonization” , accepted and to appear in IEEE Transactions on Computers (TC).
 10. Ming-Chang Yang, Yuan-Hao Chang, Tei-Wei Kuo, and **Chun-Feng Wu**, “Request Flow Coordination for Growing-Scale Solid-State Drives” , accepted and to appear in IEEE Transactions on Computers (TC).
 11. **Chun-Feng Wu**, Yuan-Hao Chang, Ming-Chang Yang, and Tei-Wei Kuo, “Joint Management of CPU and NVDIMM for Breaking Down the Great Memory Wall” , IEEE Transactions on Computers (TC), vol. 69, no. 5, pp. 722-733, May. 2020.
 12. **Chun-Feng Wu**, Ming-Chang Yang, Yuan-Hao Chang, and Tei-Wei Kuo, “Hot-Spot Suppression for Resource-Constrained Image Recognition Devices with Non-Volatile Memory” , IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), vol. 37, no. 11, pp. 2567-2577, Nov. 2018. (Integrated with ACM/IEEE EMSOFT 2018)

Conference Papers

1. Tse-Yuan Wang, **Chun-Feng Wu**, Che-Wei Tsao, Yuan-Hao Chang, and Tei-Wei Kuo, “Scheduling-Aware Prefetching: Enabling the PCIe SSD to Extend the Global Memory of GPU Device”, IEEE Nonvolatile Memory Systems and Applications Symposium (NVMSA), Virtual Conference, August 18-20, 2021.
2. Ting-Hsuan Lo, **Chun-Feng Wu**, Yuan-Hao Chang, Tei-Wei Kuo and Wei-Chen Wang, “Space-efficient Graph Data Placement to Save Energy of ReRAM Crossbar”, ACM/IEEE International Symposium on Low Power Electronics and Design (ISLPED), Virtual, Jul. 26-28, 2021. (*Top Conference*)
3. Yun-Chih Chen, **Chun-Feng Wu**, Yuan-Hao Chang, and Tei-Wei Kuo, “Reptail: Cutting Storage Tail Latency with Inherent Redundancy” , ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, USA, Dec. 5-9, 2021. (Acceptance rate: 23%) (*Top Conference*)
4. Camelia Slimani, **Chun-Feng Wu**, Stephane Rubini, Yuan-Hao Chang, and Jalil Boukhobza, “RaFIO: A Random Forest I/O-Aware Algorithm” , ACM Symposium on Applied Computing (SAC), Gwangju, South Korea, Mar. 22-26, 2020.
5. Hsiang-Yun Cheng, **Chun-Feng Wu**, Christian Hakert, Kuan-Hsun Chen, Yuan-Hao Chang, Jian-Jia Chen, Chia-Lin Yang and Tei-Wei Kuo, “Future Computing Platform Design: A Cross-Layer Design Approach” , ACM/IEEE Design Automation and Test in Europe (DATE), Virtual Conference, Feb. 1-5, 2020.
6. Yi-Shen Chen, **Chun-Feng Wu**, Yuan-Hao Chang, and Tei-Wei Kuo, “A Write-friendly

- Arithmetic Coding Scheme for Achieving Energy-Efficient Non-Volatile Memory Systems” , ACM/IEEE Asia and South Pacific Design Automation Conference (ASP-DAC), Tokyo, Japan, Jan. 18-21, 2021.
7. Gaddisa Olani Ganfure, **Chun-Feng Wu**, Yuan-Hao Chang, and Wei-Kuan Shih, “DeepGuard: Deep Generative User-behavior Analytics for Ransomware Detection” , IEEE International Conference on Intelligence and Security Informatics (ISI), Nov. 9-10, 2020.
 8. Yun-Sheng Chang, Yao Hsiao, Tzu-Chi Lin, Che-Wei Tsao, **Chun-Feng Wu**, Yuan-Hao Chang, Hsiang-Shang Ko, and Yu-Fang Chen, “Determinizing Crash Behavior with a Verified Snapshot-Consistent Flash Translation Layer” , USENIX Symposium on Operating Systems Design and Implementation (OSDI), Banff, Alberta, Canada, Nov. 4-6, 2020. (Acceptance rate: 17.6% (70/398)) (*Top Conference*)
 9. **Chun-Feng Wu**, Yuan-Hao Chang, Ming-Chang Yang, and Tei-Wei Kuo, “When Storage Response Time Catches Up with Overall Context Switch Overhead, What is Next?” , ACM/IEEE International Conference on Hardware/Software Codesign and System Synthesis (CODES+ISSS), Germany, Sep. 20 - 25, 2020. (Journal Track, Integrated with IEEE TCAD). (Acceptance rate: 21.9%(28/128)) (*Top Conference*)
 10. Yao-Wen Kang, **Chun-Feng Wu**, Yuan-Hao Chang, Tei-Wei Kuo and Shu-Yin Ho, “On Minimizing Analog Variation Errors to Resolve the Scalability Issue of ReRAM-based Crossbar Accelerator” , ACM/IEEE International Conference on Embedded Software (EMSOFT), Germany, Sep. 20 - 25, 2020. (Journal Track, Integrated with IEEE TCAD) (*Top Conference*)
 11. Gaddisa Olani Ganfure, **Chun-Feng Wu**, Yuan-Hao Chang, and Wei-Kuan Shih, “DeepPrefetcher: A Deep Learning Framework for Data Prefetching in Flash Storage Devices” , ACM/IEEE International Conference on Compilers, Architecture, and Synthesis for Embedded Systems (CASES), Germany, Sep. 20 - 25, 2020. (Journal Track, Integrated with IEEE TCAD). (*Top Conference*)
 12. Shuo-Han Chen, Yu-Pei Liang, Yuan-Hao Chang, Yun-Fei Liu, **Chun-Feng Wu**, Hsin-Wen Wei, and Wei-Kuan Shih, “Reinforcing the Energy Efficiency of Cyber-Physical Systems via Direct and Split Cache Consolidation on MLC STT-RAM” , ACM Symposium on Applied Computing (SAC), Brno, Czech Republic, Mar. 30 - Apr. 3, 2020.
 13. Yu Ting Ho, **Chun-Feng Wu**, Ming-Chang Yang, and Yuan-Hao Chang, “Replanting Your Forest: NVM-friendly Bagging Strategy for Random Forest” , IEEE Nonvolatile Memory Systems and Applications Symposium (NVMSA), Hangzhou, China, August 18-21, 2019 (Best Paper Award)
 14. Shuo-Han Chen, Ming-Chang Yang, Yuan-Hao Chang, and **Chun-Feng Wu**, “Enabling File-Oriented Fast Secure Deletion on Shingled Magnetic Recording Drives” , ACM/IEEE Design Automation Conference (DAC), Las Vegas, Nevada, USA, Jun. 2-6, 2019. (Acceptance rate: 24.8%(202/815)) (*Top Conference*)
 15. **Chun-Feng Wu**, Ming-Chang Yang, Yuan-Hao Chang, and Tei-Wei Kuo, “Hot-Spot Suppression for Resource-Constrained Image Recognition Devices with Non-Volatile Memory” , ACM/IEEE International Conference on Embedded Software (EMSOFT), Torino, Italy, Sep. 30 - Oct. 5, 2018. (Journal Track, Integrated with IEEE TCAD) (*Top Conference*)
 16. **Chun-Feng Wu**, Ming-Chang Yang, and Yuan-Hao Chang, “Improving Runtime Performance of Deduplication System with Host-Managed SMR Storage Drives” , ACM/IEEE Design Automation Conference (DAC), San Francisco, USA, Jun. 24-28, 2018. (Acceptance rate: 24.3%(168/691)) (*Top Conference*)
 17. **Chun-Feng Wu**, Tse-Chuan Hsu, Hongji Yang, and Yeh-Ching Chung, “File Placement Mechanisms for Improving Write Throughputs of Cloud Storage Services Based on Ceph and HDFS” , Proceedings of IEEE International Conference on Applied System Innovation (ICASI), Sapporo, Japan, May 2017. (The First Prize Paper Award)
 18. Su-Shien Ho, **Chun-Feng Wu**, Jiazheng Zhou, Wenguang Chen, Ching-Hsien Hsu, Hung-Chang Hsiao, and Yeh-Ching Chung. “Distributed Metaserver Mechanism and Recovery

Mechanism Support in Quantcast File System” , IEEE Computer Software and Applications Conference (COMPSAC), pages 758 - 763, Taichung, Taiwan, July. 2015.

US Patents

1. Shu-Yin Ho, Hsiang-Pang Li, Yao-Wen Kang, **Chun-Feng Wu**, Yuan-Hao Chang, Tei-Wei Kuo, “Neural Network Computation Method And Apparatus Using Adaptive Data Representation” , Patent No.: US 16,798,166, Date of Patent: Oct. 1, 2020.

AWARDS & SCHOLARSHIP

1. **Award** for ”One of the Finalist of Open Innovation Contest for AXDIMM Technology ” hosted by Samsung, 2021.
2. **Award** for ”The 1st Prize of PhD Thesis Award ” sponsored by Lam Research (科林論文獎博士論文頭等獎), 2021.
3. **Scholarship** for ”CTCI Research Scholarship ” sponsored by China Technical Consultants Inc (CTCI) Founation (中技社研究獎學金), 2021.
4. **Award** for ”Ph.D. Thesis Award ” sponsored by Taiwan Information Storage Association (TISA) (社團法人台灣資訊儲存技術協會), 2021.
5. **Award** for ”TSIA Semiconductor Award ” sponsored by Taiwan Semiconductor Industry Association (台灣半導體產業協會), 2021.
6. **Grant** for ”Postdoctoral Research Study Abroad Program ” sponsored by Ministry of Science and Technology (科技部博士後研究千里馬計畫), 2020.
7. **Scholarship** for ”Pan Wen Yuan Scholarship” sponsored by Pan Wen Yuan Foundation (財團法人潘文淵文教基金會), 2020.
8. **Scholarship** for ”Elite Scholarship” sponsored by Elite-Well Education Foundation (財團法人平安菁教育英基金會), 2020.
9. **Scholarship** for ”Student Travel Grants” sponsored by Embedded Systems Week (ESWEEK), 2018.
10. **Scholarship** for ”Outstanding Students Conference Travel Grant” sponsored by Foundation for the Advancement of Outstanding Scholarship (傑出人才發展基金會), 2018.
11. **Scholarship** for ”The international conference scholarship for young researchers” sponsored by Academia Sinica (中央研究院), 2018.

EXPERIENCES

1. Research Assistant at Academia Sinica, 2017-2021.
2. IEEE Taipei Section Webchair, 2019-2021.
3. Invited Talk Speaker of The 8th IEEE Non-Volatile Memory Systems and Applications Symposium (NVMSA), 2019.
4. PhD Forum Speaker of The 30th VLSI Design/CAD Symposium, 2019.
5. Forum Speaker of The CCF China Test Conference (CTC), 2020.
6. Tutorial Speaker of ACM/IEEE DATE, 2021.

PROJECTS

SSBox(NebulaBox)

2014-2016

National Tsing Hua University, Sytem Software Laboratory, Advisor: Yeh-Ching Chung

This project aims to provide a private cloud storage service for users. Our team designs a distributed storage system, SSBox, with high accessibility and reliability. We provide PaaS layer services for programmers to access our SSBox by RESTful API. In addition, SSBox is reliable enough to endure hundred of thousand of users to access simultaneously.

Virtual Desktop Infrastructure

2014-2015

National Tsing Hua University, System Software Laboratory, Advisor: Yeh-Ching Chung

This project aims to provide Virtual Desktops to cost down the hardware price for educational institutes. We apply a real-time virtual desktop service by using virtualization frameworks, such as OpenStack and Docker. Users just need a browser and stable Internet for accessing different Operating Systems. We also design a client side by OpenStack APIs and this design makes users to create virtual desktops easier.

SKILLS

Programming Languages

C/C++, Python, Java, Objective-C, C#, Parallel Programming(MPI), PHP, JavaScript

Tools

Docker, OpenStack, Hadoop, Ceph(Thesis), Redis, Intel Pin, Valgrind, Caffe, TensorFlow

English Certification

TOEFL: 95

SHORT BIOGRAPHY

Chun-Feng Wu is now a postdoctoral scholar in Department of Computer Science, Harvard University from 2021. He received his B.S. and M.S. degrees in department of Computer Science and Information Engineering from National Central University and in Department of Computer Science from National Tsing-Hua University in 2014 and 2016, respectively. He received his PhD degree in Department of Computer Science and Information Engineering from National Taiwan University in 2021. Previously, he served his R&D alternative service at Institute of Information Science, Academia Sinica, Taipei, Taiwan. He has published 1 US patent and 30 research papers, including papers from 12 IEEE Transactions (including IEEE TC and IEEE TCAD) and 9 top conferences (including ACM/IEEE DAC, ACM/IEEE EMSOFT, ACM/IEEE CODES+ISSS, ACM/IEEE Cases, ACM/IEEE ISLPED and USENIX OSDI). His primary research interests include memory/storage systems and architectures, operating systems, next-generation non-volatile memory, neuromorphic computing and embedded systems. He is a member in IEEE.